

#### **Description**

The AO4468 uses advanced trench technology

to provide excellent R<sub>DS(ON)</sub>, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.



SOP-8

#### **General Features**

 $V_{DS} = 30V I_{D} = 8.5A$ 

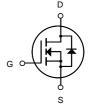
 $R_{DS(ON)}$  < 18m $\Omega$  @  $V_{GS}$ =10V

## **Application**

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

### **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
AO4468	SOP-8	4468 XXYYY	3000

# Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	ain-Source Voltage 30	
Vgs	Gate-Source Voltage	±20	V
In@T <sub>A</sub> =25°C	Continuous Drain Current <sup>1</sup>	nuous Drain Current <sup>1</sup> 8.5	
In@Ta=70°C	Continuous Drain Current <sup>1</sup>	nuous Drain Current <sup>1</sup> 5.6	
Ірм	Pulsed Drain Current <sup>2</sup>	Pulsed Drain Current <sup>2</sup> 35	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	20	mJ
las	Avalanche Current	Avalanche Current 20	
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	1.5	W
Тѕтс	Storage Temperature Range	Storage Temperature Range -55 to 150	
TJ	Operating Junction Temperature Range -55 to 150		°C
	Thermal Resistance Junction-ambient¹(t≤10s)	85	°C/W
$R_{ heta}$ JA	Thermal Resistance Junction-ambient <sup>1</sup>	25	°C/W



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.034		V/°C
<u> </u>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =7A		14	18	mΩ
R <sub>DS(ON)</sub>	Static Dialii-Source Off-Resistance	V <sub>GS</sub> =4.5V , I <sub>D</sub> =4A		20	26	
$V_{GS(th)}$	Gate Threshold Voltage	\\ -\\   =250\	1.2	1.5	2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$		-3.84		mV/°C
	Dunin Course Lookers Course	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA
Igss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =7A		6.2		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.04	2.1	Ω
Qg	Total Gate Charge (4.5V)			6	8.4	
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =7A		2.2	3.1	nC
$Q_{gd}$	Gate-Drain Charge			2	2.8	
T <sub>d(on)</sub>	Turn-On Delay Time			1.2	2.4	
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$		40	72.0	20
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =7A		18	36.0	ns
T <sub>f</sub>	Fall Time			7.2	14.4	
Ciss	Input Capacitance			583	816.2	
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		77	107.8	pF
Crss	Reverse Transfer Capacitance			59	82.6	

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,5</sup>	/-=\/-=0\/ Force Current			7	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,5</sup>	' <sub>G</sub> =V <sub>D</sub> =0V , Force Current			35	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	′ <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V
t <sub>rr</sub>	Reverse Recovery Time			7.2		nS
Qrr	Reverse Recovery Charge	==7A , dI/dt=100A/µs , T <sub>J</sub> =25°C		2.9		nC

#### Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\,\leq\,300\text{us}$  , duty cycle  $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =20A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**

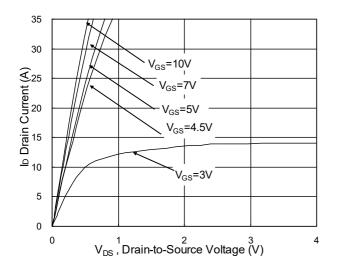


Fig.1 Typical Output Characteristics

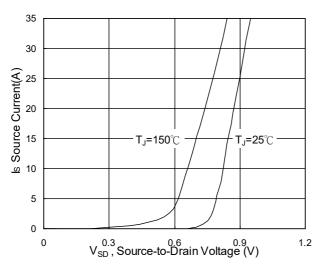


Fig.3 Forward Characteristics Of Reverse

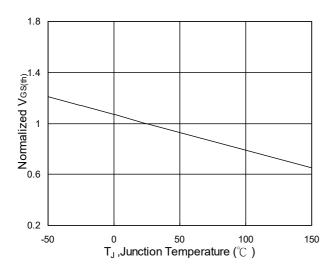


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

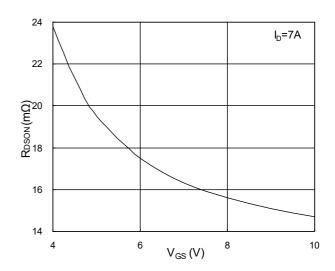


Fig.2 On-Resistance vs. Gate-Source

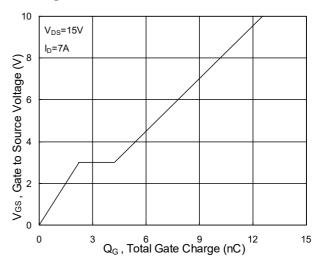


Fig.4 Gate-Charge Characteristics

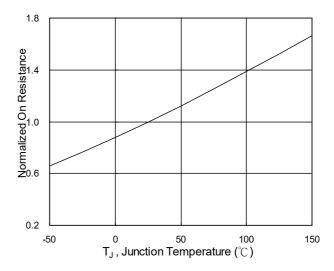
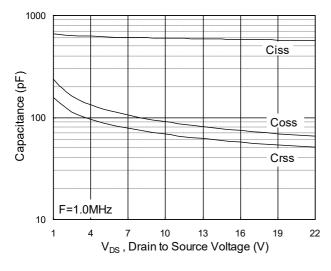


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



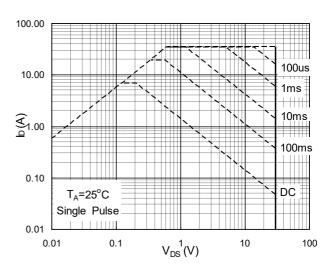


Fig.7 Capacitance

Fig.8 Safe Operating Area

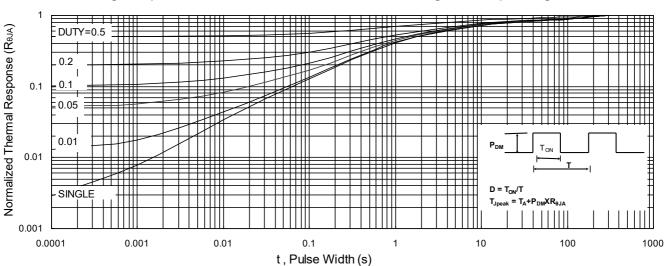


Fig.9 Normalized Maximum Transient Thermal Impedance

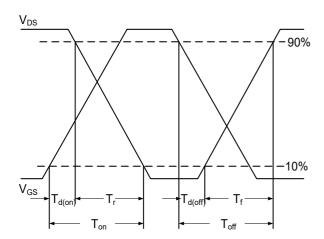


Fig.10 Switching Time Waveform

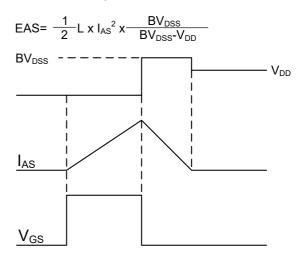
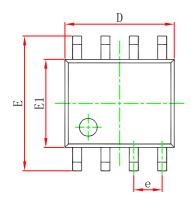
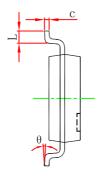


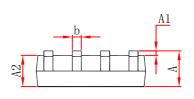
Fig.11 Unclamped Inductive Switching Waveform



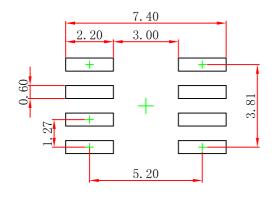
# **SOP-8 Package Outline Dimensions**







Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
c	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0. 197	
e	1. 270 (	BSC)	0.050 (BSC)		
E	5.800	6.200	0. 228	0. 244	
E1	3.800	4.000	0.150	0. 157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



- Note: 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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